



RE966-03E

- Adapter QFP80
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for QFP80 with 0.80 mm pitch
- Hole spacing 2.54 mm
- Hole diameter 1.10 mm with solder pads Ø 2.10 mm
- External switching options on the bottom side with 0603 SMD-Pads one pin each
- Resistors or similar components can be mounted directly
- Shield pad & cooling field
- Size 43.81 x 48.90 mm